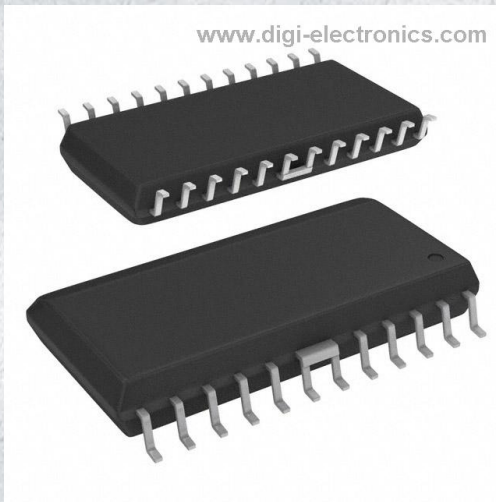


# A3959SLBTR-T Datasheet



<https://www.DiGi-Electronics.com>

DiGi Electronics Part Number	A3959SLBTR-T-DG
Manufacturer	<a href="#">Allegro MicroSystems</a>
Manufacturer Product Number	A3959SLBTR-T
Description	IC MOTOR DRIVER 4.5V-5.5V 24SOIC
Detailed Description	Motor Driver DMOS Parallel 24-SOIC



Tel: +00 852-30501935

RFQ Email: [Info@DiGi-Electronics.com](mailto:Info@DiGi-Electronics.com)

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## Purchase and inquiry

Manufacturer Product Number:

A3959SLBTR-T

Series:

-

Motor Type - Stepper:

-

Function:

Driver - Fully Integrated, Control and Power Stage

Interface:

Parallel

Step Resolution:

-

Current - Output:

3A

Voltage - Load:

9.5V ~ 50V

Mounting Type:

Surface Mount

Supplier Device Package:

24-SOIC

Manufacturer:

Allegro MicroSystems

Product Status:

Active

Motor Type - AC, DC:

Brushed DC

Output Configuration:

Half Bridge (2)

Technology:

DMOS

Applications:

General Purpose

Voltage - Supply:

4.5V ~ 5.5V

Operating Temperature:

-20°C ~ 150°C (TJ)

Package / Case:

24-SOIC (0.295", 7.50mm Width)

Base Product Number:

A3959

## Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8542.39.0001

Moisture Sensitivity Level (MSL):

3 (168 Hours)

ECCN:

EAR99



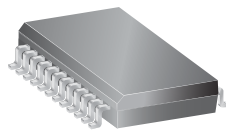
## DMOS Full-Bridge PWM Motor Driver

### FEATURES AND BENEFITS

- $\pm 3$  A, 50 V Output Rating
- Low  $r_{DS(on)}$  Outputs (270 m $\Omega$ , Typical)
- Mixed, Fast, and Slow Current-Decay Modes
- Synchronous Rectification for Low Power Dissipation
- Internal UVLO and Thermal-Shutdown Circuitry
- Crossover-Current Protection
- Internal Oscillator for Digital PWM Timing

### PACKAGES:

Package LB, 24-pin SOIC  
with internally fused pins



Package LP, 28-pin TSSOP  
with exposed thermal pad



*Not to scale*

### DESCRIPTION

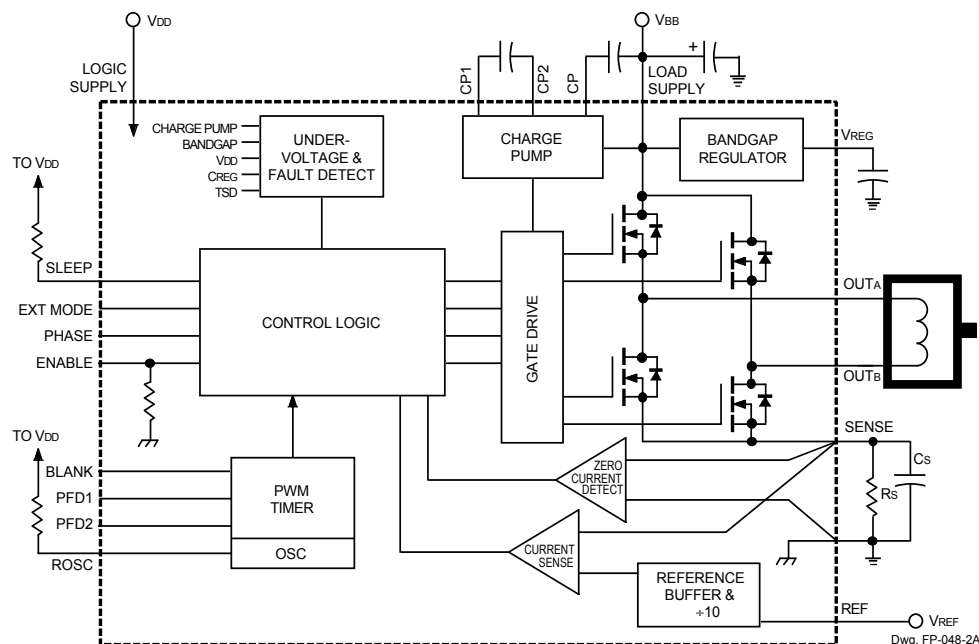
Designed for pulse width modulated (PWM) current control of DC motors, the A3959 is capable of output currents to  $\pm 3$  A and operating voltages to 50 V. Internal fixed off-time PWM current-control timing circuitry can be adjusted via control inputs to operate in slow, fast, and mixed current-decay modes.

PHASE and ENABLE input terminals are provided for use in controlling the speed and direction of a DC motor with externally applied PWM-control signals. Internal synchronous rectification control circuitry is provided to reduce power dissipation during PWM operation.

Internal circuit protection includes thermal shutdown with hysteresis, undervoltage monitoring of supply and charge pump, and crossover-current protection. Special power-up sequencing is not required.

The A3959 provides a choice of two power packages: a 24-lead SOIC with four internally fused pins (package suffix 'LB'), and a thin (<1.2 mm) 28-pin TSSOP with an exposed thermal pad (suffix 'LP'). In all cases, the power pins and tabs are at ground potential and need no electrical isolation. Each package is lead (Pb) free, with 100% matte tin leadframes.

### Functional Block Diagram



# A3959

# DMOS Full-Bridge PWM Motor Driver

## SELECTION GUIDE

Part Number	Package	Packing
A3959SLBTR-T	24-pin SOIC with internally fused pins	1000 per reel
A3959SLPTR-T	28-pin TSSOP with exposed thermal pad	4000 per reel

## ABSOLUTE MAXIMUM RATINGS

Characteristic	Symbol	Notes	Rating	Units	
Load Supply Voltage	$V_{BB}$		50	V	
Logic Supply Voltage	$V_{DD}$		7.0	V	
Input Voltage	$V_{IN}$	Continuous	-0.3 to $V_{DD} + 0.3$	V	
		$t_w < 30$ ns	-1.0 to $V_{DD} + 1.0$	V	
Sense Voltage	$V_S$	Continuous	0.5	V	
		$t_w < 3$ $\mu$ s	2.5	V	
Reference Voltage	$V_{REF}$		$V_{DD}$	V	
Output Current	$I_{OUT}$	Output current rating may be limited by duty cycle, ambient temperature, and heat sinking. Under any set of conditions, do not exceed the specified current rating or a junction temperature of 150°C.	Repetitive	$\pm 3.0$	A
			Peak, $< 3$ $\mu$ s	$\pm 6.0$	A
Package Power Dissipation	$P_D$	See Thermal Characteristics	-	-	
Operating Ambient Temperature	$T_A$	Range S	-20 to 85	°C	
Maximum Junction Temperature	$T_J(\max)$	Fault conditions that produce excessive junction temperature will activate the device's thermal shutdown circuitry. These conditions can be tolerated but should be avoided.	150	°C	
Storage Temperature	$T_{stg}$		-55 to 150	°C	

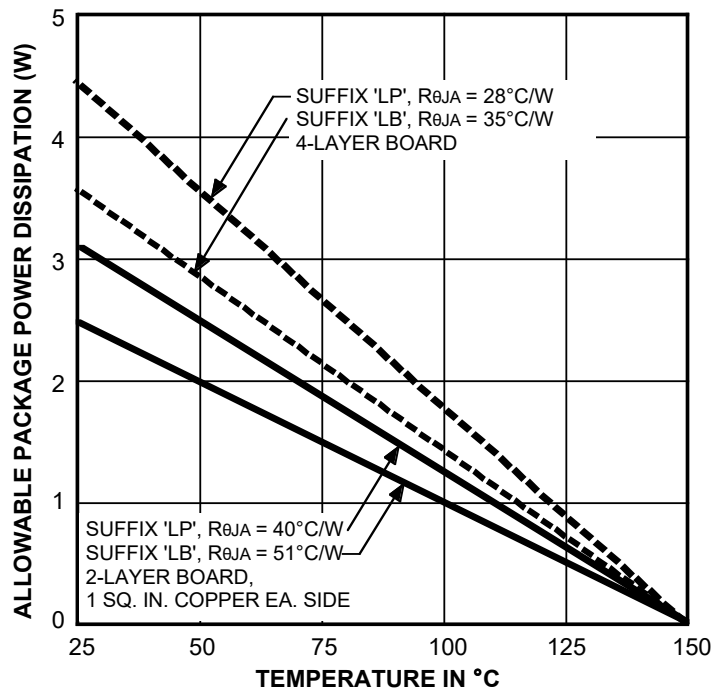
# A3959

# DMOS Full-Bridge PWM Motor Driver

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Test Conditions	Value	Units	
Package Power Dissipation	$P_D$	LB package	2.5	W	
		LP package	3.1	W	
Package Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	LB Package	1-layer PCB, minimal exposed copper area	77	$^{\circ}\text{C}/\text{W}$
			2-layer PCB, 1-in <sup>2</sup> 2-oz copper exposed area	51	$^{\circ}\text{C}/\text{W}$
			4-layer PCB, based on JEDEC standard	35	$^{\circ}\text{C}/\text{W}$
		LP Package	1-layer PCB, minimal exposed copper area	100	$^{\circ}\text{C}/\text{W}$
			2-layer PCB, 1-in <sup>2</sup> 2-oz copper exposed area	40	$^{\circ}\text{C}/\text{W}$
			4-layer PCB, based on JEDEC standard	28	$^{\circ}\text{C}/\text{W}$
Package Thermal Resistance, Junction to Tab	$R_{\theta JT}$	LB package	6	$^{\circ}\text{C}/\text{W}$	
Package Thermal Resistance, Junction to Pad	$R_{\theta JP}$	LP package	2	$^{\circ}\text{C}/\text{W}$	

\*Additional thermal information available on Allegro website.



## A3959

## DMOS Full-Bridge PWM Motor Driver

**ELECTRICAL CHARACTERISTICS at  $T_A = +25^\circ\text{C}$ ,  $V_{BB} = 50\text{ V}$ ,  $V_{DD} = 5.0\text{ V}$ ,  $V_{SENSE} = 0.5\text{ V}$ ,  $f_{PWM} < 50\text{ kHz}$  (unless noted otherwise)**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
<b>OUTPUT DRIVERS</b>						
Load Supply Voltage Range	$V_{BB}$	Operating	9.5	–	50	V
		During sleep mode	0	–	50	V
Output Leakage Current	$I_{DSS}$	$V_{OUT} = V_{BB}$	–	<1.0	20	$\mu\text{A}$
		$V_{OUT} = 0\text{ V}$	–	<–1.0	–20	$\mu\text{A}$
Output On Resistance	$r_{DS(on)}$	Source driver, $I_{OUT} = -3\text{ A}$	–	270	300	$\text{m}\Omega$
		Sink driver, $I_{OUT} = 3\text{ A}$	–	270	300	$\text{m}\Omega$
Crossover Delay			300	600	1000	ns
Body Diode Forward Voltage	$V_F$	Source diode, $I_F = -3\text{ A}$	–	–	1.6	V
		Sink diode, $I_F = 3\text{ A}$	–	–	1.6	V
Load Supply Current	$I_{BB}$	$f_{PWM} < 50\text{ kHz}$	–	4.0	7.0	mA
		Charge pump on, outputs disabled	–	2.0	5.0	mA
		Sleep mode	–	–	20	$\mu\text{A}$
<b>CONTROL LOGIC</b>						
Logic Supply Voltage Range	$V_{DD}$	Operating	4.5	5.0	5.5	V
Logic Input Voltage	$V_{IN(1)}$		2.0	–	–	V
	$V_{IN(0)}$		–	–	0.8	V
Logic Input Current (all inputs except ENABLE)	$I_{IN(1)}$	$V_{IN} = 2.0\text{ V}$	–	<1.0	20	$\mu\text{A}$
	$I_{IN(0)}$	$V_{IN} = 0.8\text{ V}$	–	<–2.0	–20	$\mu\text{A}$
Logic Supply Current	$I_{DD}$	$f_{PWM} < 50\text{ kHz}$	–	6.0	10	mA
		Sleep mode	–	–	2.0	mA
ENABLE Input Current	$I_{IN(1)}$	$V_{IN} = 2.0\text{ V}$	–	40	100	$\mu\text{A}$
	$I_{IN(0)}$	$V_{IN} = 0.8\text{ V}$	–	16	40	$\mu\text{A}$
Internal OSC Frequency	$f_{OSC}$	$R_{OSC}$ shorted to GROUND	3.25	4.25	5.25	MHz
		$R_{OSC} = 51\text{ k}\Omega$	3.65	4.25	4.85	MHz
Reference Input Voltage Range	$V_{REF}$	Operating	0.0	–	$V_{DD}$	V
Reference Input Current	$I_{REF}$	$V_{REF} = V_{DD}$	–	–	$\pm 1.0$	$\mu\text{A}$
Comparator Input Offset Voltage	$V_{IO}$	$V_{REF} = 0\text{ V}$	–	$\pm 5.0$	–	mV

Continued next page ...

**A3959****DMOS Full-Bridge PWM Motor Driver**

**ELECTRICAL CHARACTERISTICS (continued) at  $T_A = +25^\circ\text{C}$ ,  $V_{BB} = 50\text{ V}$ ,  $V_{DD} = 5.0\text{ V}$ ,  $V_{SENSE} = 0.5\text{ V}$ ,  $f_{PWM} < 50\text{ kHz}$  (unless noted otherwise)**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Reference Divider Ratio	–		–	10	–	–
Gm Error (Note 3)	$E_{Gm}$	$V_{REF} = V_{DD}$	–	–	$\pm 4.0$	%
		$V_{REF} = 0.5\text{ V}$	–	–	$\pm 14$	%
Propagation Delay Times	$t_{pd}$	0.5 $E_{in}$ to 0.9 $E_{out}$ :				
		PWM change to source on	600	750	1200	ns
		PWM change to source off	50	150	350	ns
		PWM change to sink on	600	750	1200	ns
		PWM change to sink off	50	100	150	ns
Thermal Shutdown Temp.	$T_J$		–	165	–	$^\circ\text{C}$
Thermal Shutdown Hysteresis	$\Delta T_J$		–	15	–	$^\circ\text{C}$
UVLO Enable Threshold	$V_{UVLO}$	Increasing $V_{DD}$	3.90	4.2	4.45	V
UVLO Hysteresis	$\Delta V_{UVLO}$		0.05	0.10	–	V

- NOTES:
1. Typical Data is for design information only.
  2. Negative current is defined as coming out of (sourcing) the specified device terminal.
  3.  $G_m$  error =  $([V_{REF}/10] - V_{SENSE})/(V_{REF}/10)$  where  $V_{SENSE} = I_{TRIP} \cdot R_S$ .

## A3959

## DMOS Full-Bridge PWM Motor Driver

## FUNCTIONAL DESCRIPTION

**V<sub>REG</sub>.** This internally generated voltage is used to operate the sink-side DMOS outputs. The V<sub>REG</sub> terminal should be decoupled with a 0.22 μF capacitor to ground. V<sub>REG</sub> is internally monitored and in the case of a fault condition, the outputs of the device are disabled.

**Charge Pump.** The charge pump is used to generate a gate-supply voltage greater than V<sub>BB</sub> to drive the source-side DMOS gates. A 0.22 μF ceramic capacitor should be connected between CP1 and CP2 for pumping purposes. A 0.22 μF ceramic capacitor should be connected between CP and V<sub>BB</sub> to act as a reservoir to operate the high-side DMOS devices. The CP voltage is internally monitored and, in the case of a fault condition, the source outputs of the device are disabled.

**PHASE Logic.** The PHASE input terminal determines if the device is operating in the “forward” or “reverse” state.

PHASE	OUT <sub>A</sub>	OUT <sub>B</sub>
0	Low	High
1	High	Low

**ENABLE Logic.** The ENABLE input terminal allows external PWM. ENABLE high turns on the selected sink-source pair. ENABLE low switches off the source driver or the source and sink driver, depending on EXT MODE, and the load current decays. If ENABLE is kept high, the current will rise until it reaches the level set by the internal current-control circuit.

ENABLE	Outputs
0	Chopped
1	On

**EXT MODE Logic.** When using external PWM current control, the EXT MODE input determines the current path during the chopped cycle. With EXT MODE low, fast decay mode, the opposite pair of selected outputs will be enabled during the off cycle. With EXT MODE high, slow decay mode, both sink drivers are on with ENABLE low.

EXT MODE	Decay
0	Fast
1	Slow

**Current Regulation.** Load current is regulated by an internal fixed off-time PWM control circuit. When the outputs of the DMOS H bridge are turned on, the current increases in the motor winding until it reaches a trip value determined by the external sense resistor (R<sub>S</sub>) and the applied analog reference voltage (V<sub>REF</sub>):

$$I_{TRIP} = V_{REF}/10R_S$$

At the trip point, the sense comparator resets the source-enable latch, turning off the source driver. The load inductance then causes the current to recirculate for the fixed off-time period. The current path during recirculation is determined by the configuration of slow/mixed/fast current-decay mode via PFD1 and PFD2.

**Oscillator.** The PWM timer is based on an internal oscillator set by a resistor connected from the R<sub>OSC</sub> terminal to V<sub>DD</sub>. Typical value of 4 MHz is set with a 51 kΩ resistor. The allowable range of the resistor is from 20 kΩ to 100 kΩ.

$$f_{OSC} = 204 \times 10^9/R_{OSC}$$

If R<sub>OSC</sub> is not pulled up to V<sub>DD</sub>, it must be shorted to ground.

**Fixed Off Time.** The A3959 is set for a fixed off time of 96 cycles of the internal oscillator, typically 24 μs with a 4 MHz oscillator.



## A3959

## DMOS Full-Bridge PWM Motor Driver

## FUNCTIONAL DESCRIPTION (continued)

**Internal Current-Control Mode.** Inputs PFD1 and PFD2 determine the current-decay method after an overcurrent event is detected at the SENSE input. In slow-decay mode, both sink drivers are turned on for the fixed off-time period. Mixed-decay mode starts out in fast-decay mode for a portion (15% or 48%) of the fixed off time, and then is followed by slow decay for the remainder of the period.

PFD2	PFD1	% $t_{off}$	Decay
0	0	0	Slow
0	1	15	Mixed
1	0	48	Mixed
1	1	100	Fast

**PWM Blank Timer.** When a source driver turns on, a current spike occurs due to the reverse-recovery currents of the clamp diodes and/or switching transients related to distributed capacitance in the load. To prevent this current spike from erroneously resetting the source-enable latch, the sense comparator is blanked. The blank timer runs after the off-time counter to provide the blanking function. The blank timer is reset when ENABLE is chopped or PHASE is changed. For external PWM control, a PHASE change or ENABLE on will trigger the blanking function. The duration is determined by the BLANK input and the oscillator.

BLANK	$t_{blank}$
0	$6/f_{osc}$
1	$12/f_{osc}$

**Synchronous Rectification.** When a PWM off cycle is triggered, either by an ENABLE chop command or internal fixed off-time cycle, load current will recirculate according to the decay mode selected by the control logic. The A3959 synchronous rectification feature will turn on

the appropriate pair of DMOS outputs during the current decay and effectively short out the body diodes with the low  $r_{DS(on)}$  driver. This will reduce power dissipation significantly and can eliminate the need for external Schottky diodes.

Synchronous rectification will prevent reversal of load current by turning off all outputs when a zero-current level is detected.

**Shutdown.** In the event of a fault (excessive junction temperature, or low voltage on CP or  $V_{REG}$ ) the outputs of the device are disabled until the fault condition is removed. At power up, and in the event of low  $V_{DD}$ , the UVLO circuit disables the drivers.

**Braking.** The braking function is implemented by driving the device in slow-decay mode via EXTMODE and applying an enable chop command. Because it is possible to drive current in either direction through the DMOS drivers, this configuration effectively shorts out the motor-generated BEMF as long as the ENABLE chop mode is asserted. It is important to note that the internal PWM current-control circuit will not limit the current when braking, because the current does not flow through the sense resistor. The maximum brake current can be approximated by  $V_{BEMF}/R_L$ . Care should be taken to ensure that the maximum ratings of the device are not exceeded in worst-case braking situations of high speed and high inertial loads.

**SLEEP Logic.** The SLEEP input terminal is used to minimize power consumption when not in use. This disables much of the internal circuitry including the regulator and charge pump. Logic low will put the device into sleep mode, logic high will allow normal operation.

Note: If the sleep mode is not used, connect a 5 k $\Omega$  pull-up resistor between the SLEEP terminal and  $V_{DD}$ .

# A3959

# DMOS Full-Bridge PWM Motor Driver

## FUNCTIONAL DESCRIPTION (continued)

**Current Sensing.** To minimize inaccuracies in sensing the  $I_{TRIP}$  current level, which may be caused by ground trace IR drops, the sense resistor should have an independent ground return to the ground terminal of the device. For low-value sense resistors the IR drops in the PCB sense resistor's traces can be significant and should be taken into account. The use of sockets should be avoided as they can introduce variation in  $R_S$  due to their contact resistance.

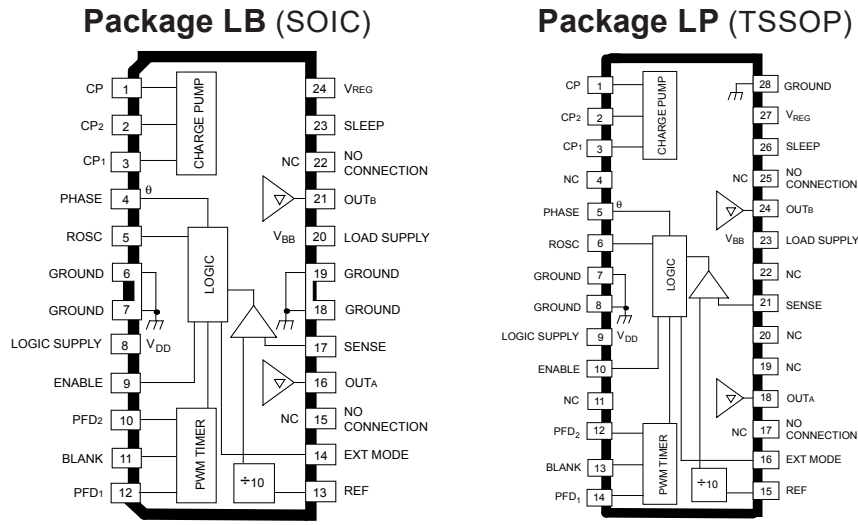
The maximum value of  $R_S$  is given as  $R_S = 0.5/I_{TRIP}$ .

**Thermal Protection.** Circuitry turns off all drivers when the junction temperature reaches 165°C typically. It is intended only to protect the device from failures due to excessive junction temperatures and should not imply that output short circuits are permitted. Thermal shutdown has a hysteresis of approximately 15°C.

**Layout.** A star ground system located close to the driver is recommended. The printed wiring board should use a heavy ground plane. For optimum electrical and thermal performance, the driver should be soldered directly onto the board. The ground side of  $R_S$  should have an individual path to the ground terminals of the device. This path should be as short as is possible physically and should not have any other components connected to it. It is recommended that a 0.1  $\mu$ F capacitor be placed between SENSE and ground as close to the device as possible; the load supply terminal,  $V_{BB}$ , should be decoupled with an electrolytic capacitor (> 47  $\mu$ F is recommended) placed as close to the device as is possible. On the 28-lead TSSOP package, the copper ground plane located under the exposed thermal pad is typically used as a star ground.

## A3959

## DMOS Full-Bridge PWM Motor Driver



Dwg. PP-069-4

## Terminal List

Terminal Name	Terminal Description	LB (SOIC)	LP (TSSOP)
CP	Reservoir capacitor (typically 0.22 $\mu$ F)	1	1
CP1 & CP2	The charge pump capacitor (typically 0.22 $\mu$ F)	2 & 3	2 & 3
NC	No (internal) connection	—	4
PHASE	Logic input for direction control	4	5
ROSC	Oscillator resistor	5	6
GROUND	Grounds	6, 7	7, 8*
LOGIC SUPPLY	VDD, the low voltage (typically 5 V) supply	8	9
ENABLE	Logic input for enable control	9	10
NC	No (internal) connection	—	11
PFD2	Logic-level input for fast decay	10	12
BLANK	Logic-level input for blanking control	11	13
PFD1	Logic-level input for fast decay	12	14
REF	VREF, the load current reference input voltage	13	15
EXT MODE	Logic input for PWM mode control	14	16
NO CONNECT	No (Internal) connection	15	17
OUTA	One of two DMOS bridge outputs to the motor	16	18
NC	No (internal) connection	—	19, 20
SENSE	Sense resistor	17	21
NC	No (internal) connection	—	22
GROUND	Grounds	18, 19	—
LOAD SUPPLY	VBB, the high-current, 9.5 V to 50 V, motor supply	20	23
OUTB	One of two DMOS bridge outputs to the motor	21	24
NO CONNECT	No (Internal) connection	22	25
SLEEP	Logic-level Input for sleep operation	23	26
VREG	Regulator decoupling capacitor (typically 0.22 $\mu$ F)	24	27
GROUND	Ground	—	28*

\* For the LP (TSSOP) package, the grounds at terminals 7, 8, and 28 should be connected together at the exposed pad beneath the device.

# A3959

# DMOS Full-Bridge PWM Motor Driver

## LB package 24-pin SOICW For Reference Only – Not for Tooling Use

(Reference Allegro DWG-0000388, Rev. 1 and JEDEC MS-013AD)

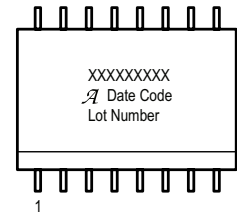
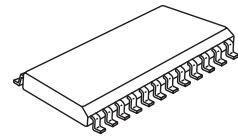
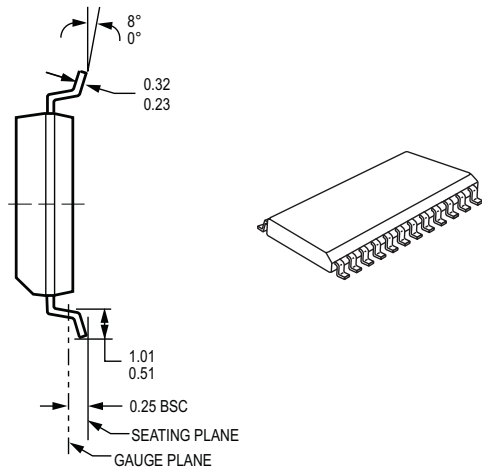
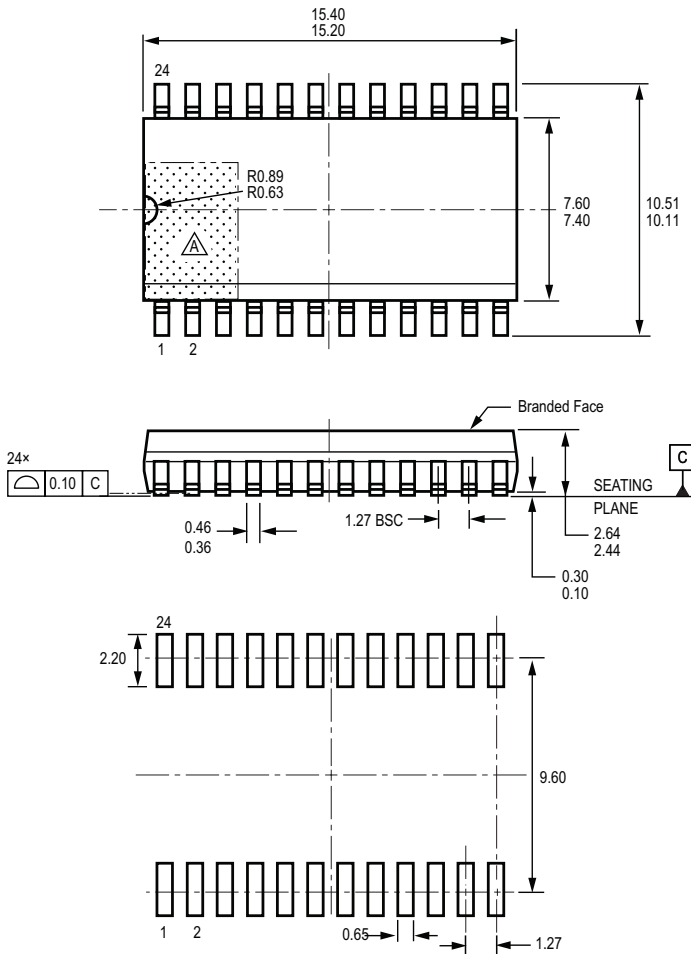
NOT TO SCALE

Dimensions in millimeters

Dimensions exclusive of mold flash, gate burrs, and dambar protrusions

Exact case and lead configuration at supplier discretion within limits shown

Internal configuration of fused pins is device-dependent



### Standard Branding Reference View

Line 1, 2, 3 = 15 Characters

Line 1: Part Number  
Line 2: Logo A, 4 digit Date Code  
Line 3: Assembly Lot Number

### PCB Layout Reference View

- △ Terminal #1 mark area
- △ Reference pad layout (reference IPC SOIC127P1030X265-24M)  
All pads a minimum of 0.20 mm from all adjacent pads; adjust as necessary to meet application process requirements and PCB layout tolerances
- △ Branding scale and appearance at supplier discretion



# A3959

# DMOS Full-Bridge PWM Motor Driver

## LP package 28-pin TSSOP

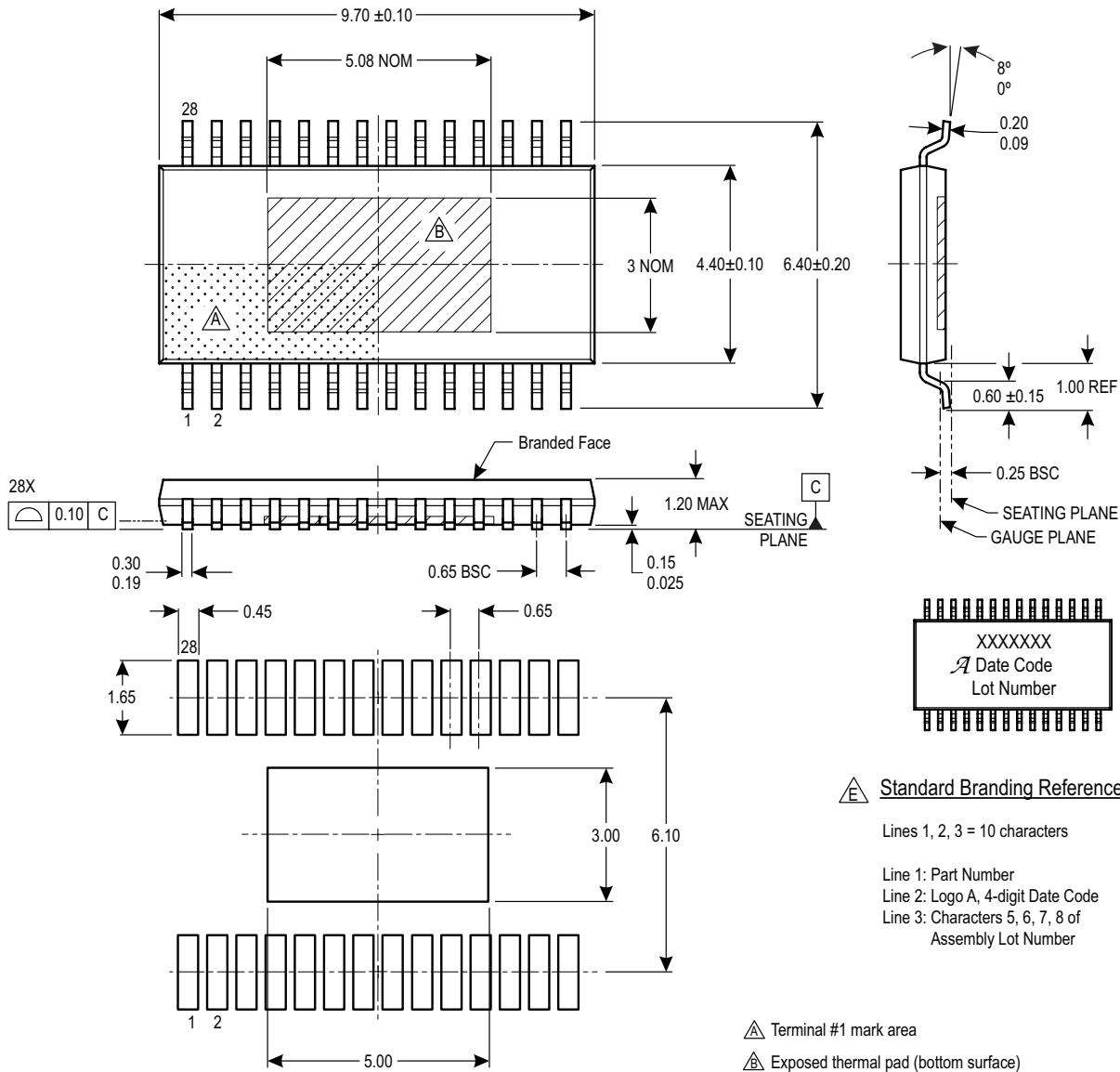
### For Reference Only – Not for Tooling Use

(Reference Allegro DWG-0000379, Rev. 3 and JEDEC MO-153AET)

Dimensions in millimeters – NOT TO SCALE

Dimensions exclusive of mold flash, gate burrs, and dambar protrusions

Exact case and lead configuration at supplier discretion within limits shown



### △ Standard Branding Reference View

Lines 1, 2, 3 = 10 characters

Line 1: Part Number  
 Line 2: Logo A, 4-digit Date Code  
 Line 3: Characters 5, 6, 7, 8 of Assembly Lot Number

### △ PCB Layout Reference View

△ Terminal #1 mark area

△ Exposed thermal pad (bottom surface)

△ Reference land pattern layout (reference IPC7351 SOP65P640X120-29CM); All pads a minimum of 0.20 mm from all adjacent pads; adjust as necessary to meet application process requirements and PCB layout tolerances; when mounting on a multilayer PCB, thermal vias at the exposed thermal pad land can improve thermal dissipation (reference EIA/JEDEC Standard JESD51-5)

△ Branding scale and appearance at supplier discretion.

# A3959

# DMOS Full-Bridge PWM Motor Driver

## REVISION HISTORY

Number	Date	Description
13	November 1, 2019	Minor editorial updates
14	October 21, 2022	Removed discontinued B package option; updated package drawings (pages 10-11)

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